

Series: Domino

TECHNICAL DATA SHEET

Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Features:

- 868MHz ISM antenna
- Size 21.85 x 5 x 3 mm
- Efficiency 60%
- Nominal impedance 50 Ω
- Fully SMD and Reflow/IR/Wave- soldering compatible

Applications:

- 868MHz radios
- M2M
- IoT
- SigFox
- LoRa





All dimensions are in mm / inches

Issue: 1905

In the effort to improve our products, we reserve the right to make changes judged to be necessary. CONFIDENTIAL AND PROPRIETARY INFORMATION

This document contains confidential and proprietary information of Pulse Electronics, Inc. (Pulse) and is protected by copyright, trade secret and other state and federal laws. Its receipt or possession does not convey any rights to reproduce, disclose its contents, or to manufacture, use or sell anything it may describe. Reproduction, disclosure or use without specific written authorization of Pulse is strictly forbidden. For more information:



Pulse/Larsen Antennas 18110 SE 34th St Bldg 2 Suite 250 Vancouver, WA 98683 USA Tel: 1-360-944-7551 Europe Headquarters Pulse GmbH & Do, KG Zeppelinstrasse 15 Herrenberg, Germany Tel: 49 7032 7806 0 Pulse (Suzhou) Wireless Products Co, Inc. 99 Huo Ju Road(#29 Bldg,4th Phase Suzhou New District Jiangsu Province, Suzhou 215009 PR China Tel: 86 512 6807 9998



Maximum power input

TECHNICAL DATA SHEET

5 W

Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

ELECTRICAL SPECIFICATIONS

Frequency	868 MHz
Nominal Impedance	50Ω
Return loss	-10 dB
Total Efficiency	60 %
Peak Gain	0.17 dBi

(*) All RF parameters measured on Pulse reference test PCB



Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

MECHANICAL SPECIFICATIONS

Color Black

Size(L X W X T) 21.85 x 5 x 3 mm

Weight 1.3 g

Fixing system SMD

MSL level 3

ENVIRONMENTAL SPECIFICATIONS

Operating temperature -40/+85 ° C

Temperature -40/+85 ° C

Humidity 93% RH @ 30° C 24 hours

Drop test 1 m



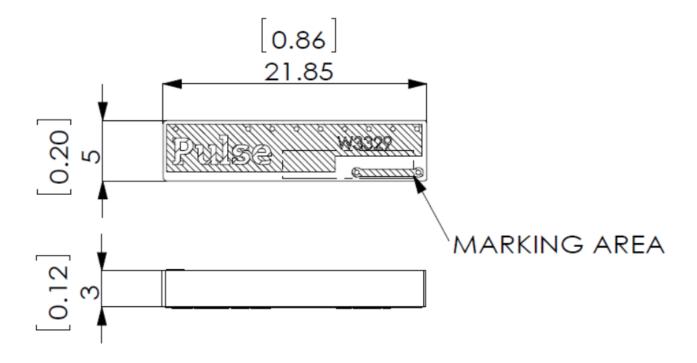


Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

MECHANICAL DRAWING





DIMENSION UNIT IS [INCH]MM



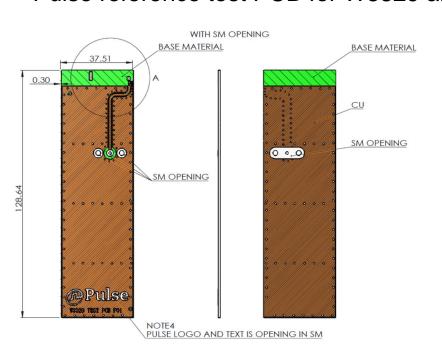
Description: 868MHz PCB SMT Antenna

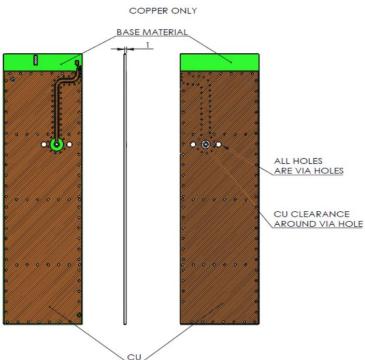
PART NUMBER: W3329

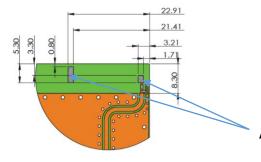
Series: Domino

TEST SETUP

Pulse reference test PCB for W3329 antenna







Antenna soldering pad



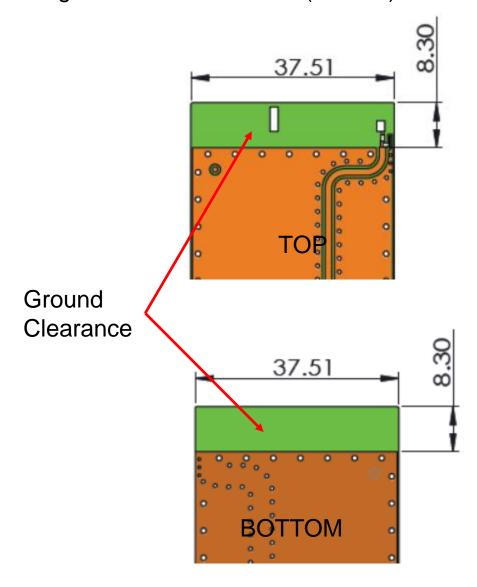
Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

TEST SETUP

PWB ground clearance area (Top):37.5x8.3mm PWB ground clearance area (Bottom):37.5x8.3mm







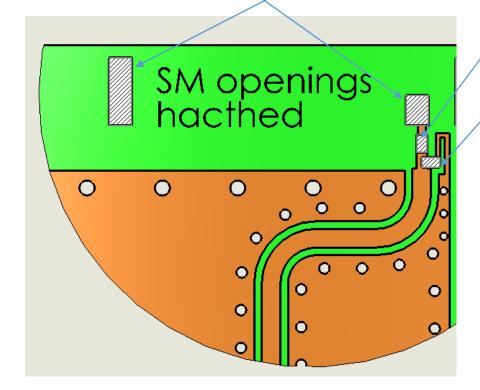
Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

TEST SETUP

Antenna soldering pad



LBser=15nH (Murata LQW15AN)

LBshunt=3p3F (Murata GJM15)

Recommended test board PCB layout for electrical characteristic measurement. Substrate material FR4, thickness 1mm

All dimensions are in mm



Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

TEST SETUP

Recommendation for reflow soldering process

Printing stencil thickness 0,15 - 0,25 mm is recommended for the solder paste. The maximum soldering temperature should not exceed 260°C. The temperature profile recommendations for reflow soldering process is presented in the Figures 1 and 2. The reflow profile

presented in figure 1 describes minimum reflow temperatures. The reflow profile presented in figure 2 describes maximum reflow temperatures. located at the center of the coverage area.

П		Method of heat transfer	Controlled hot air convection
	1	Average temperature gradient in preheating	2.5 °C/s
	2	Soak time	2-3 minutes
Г	3	Max temperature gradient in reflow	3 °C/s
	4	Time above 217 °C	Max 30 sec
	5	Peak temperature in reflow	230 °C for 10 seconds
L	6	Temperature gradient in cooling	Max -5 °C/s

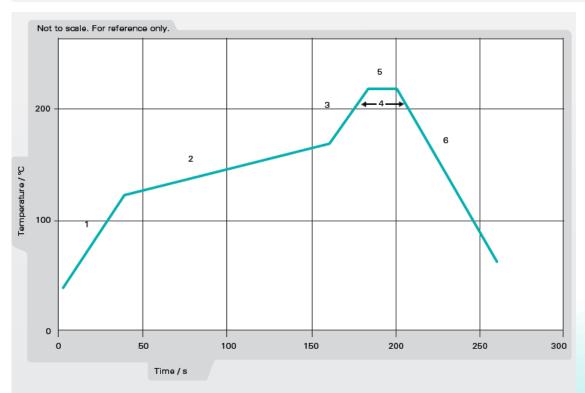


Figure 1. Minimum temperature profile recommendation for reflow soldering process



Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

TEST SETUP

	Method of heat transfer	Controlled hot air convection
1	Average temperature gradient in preheating	2.5 °C/s
2	Soak time	2-3 minutes
3	Max temperature gradient in reflow	3 °C/s
4	Time above 217 °C	Max 60 sec
5	Time above 230 °C	Max 50 sec
6	Time above 250 °C	Max 10 sec
7	Peak temperature in reflow	260 °C for 5 seconds
8	Temperature gradient in cooling	Max -5 °C/s

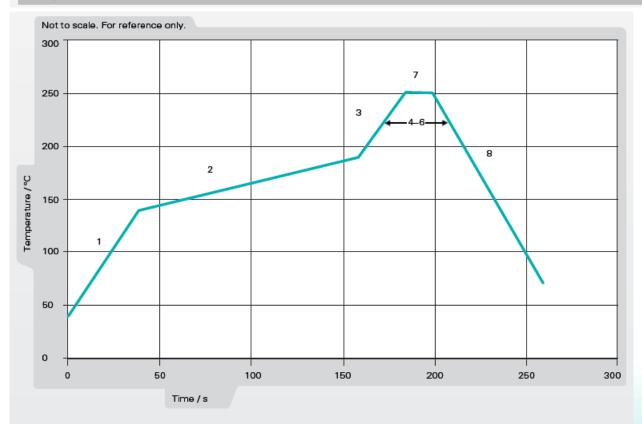


Figure 2. Maximum temperature profile recommendation for reflow soldering process



Description: 868MHz PCB SMT Antenna

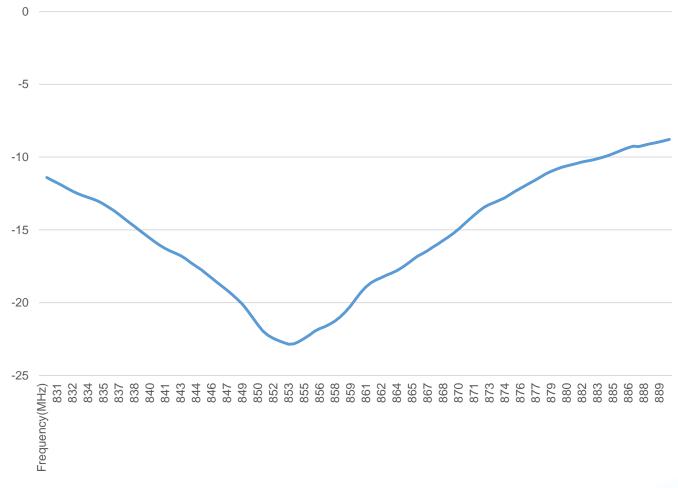
PART NUMBER: W3329

Series: Domino

CHARTS

Return Loss

Return Loss





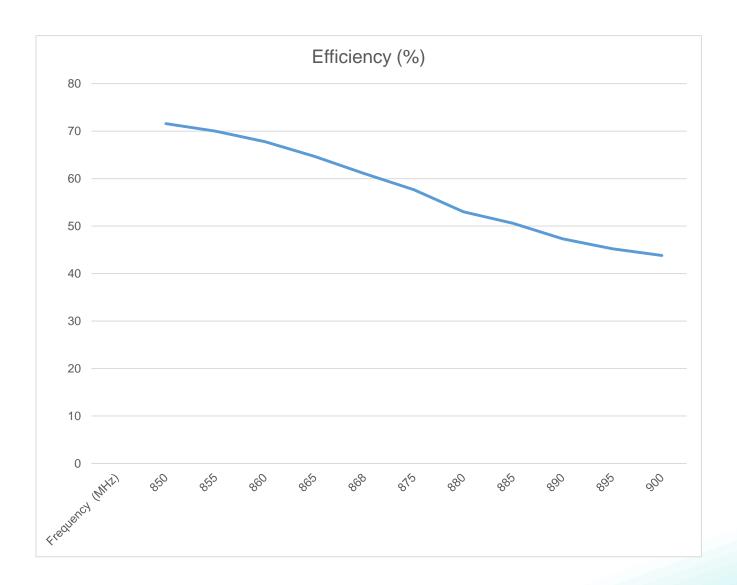
Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

CHARTS

Efficiency(%)







Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

CHARTS

Peak Gain(dBi)





Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

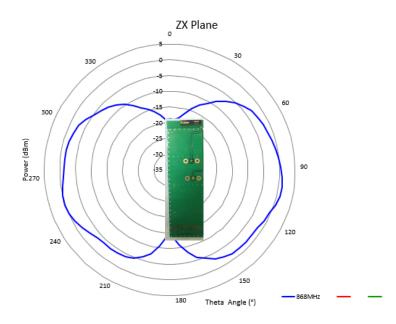
Series: Domino

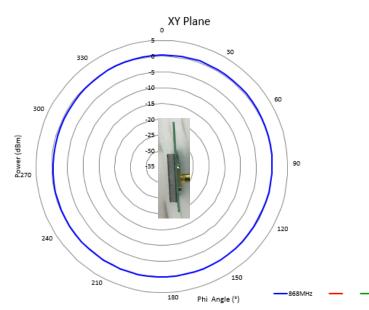
CHARTS

Free Space Radiation Pattern

Elevation Plane

Horizontal Plane







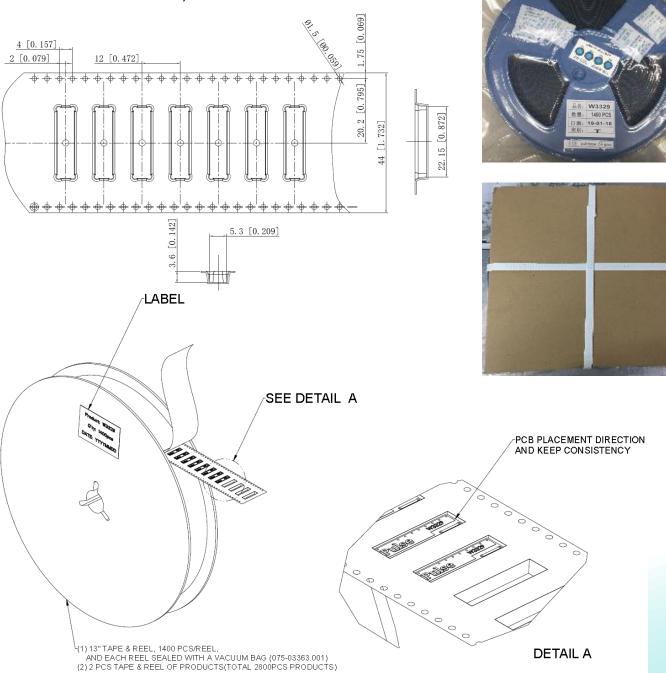
Description: 868MHz PCB SMT Antenna

PART NUMBER: W3329

Series: Domino

PACKAGING (TAPE & REEL)

Reel packing, 1400 PCS/Reel 2 Reels/Carton box, total 2800 PCS/Carton box



Issue. 1905

In the effort to improve our products, we reserve the right to make changes judged to be necessary. CONFIDENTIAL AND PROPRIETARY INFORMATION



ПОСТАВКА ЭЛЕКТРОННЫХ КОМПОНЕНТОВ

Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

Данный компонент на территории Российской Федерации Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г. Москва, ул. Щербаковская д. 3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru moschip.ru_6 moschip.ru_4 moschip.ru_9